

# Tunneling of X-ray Photons through a Thin Film under Total Internal Reflection Conditions

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Tunneling of 0.154- and 0.139-nm x-ray photons through a thin film under total internal reflection conditions has been experimentally demonstrated. The NiSi<sub>2</sub> film 13 nm thick is deposited by magnetron sputtering on a polished Si substrate. A beam with an angular spread of 20'' is directed to the Si/NiSi<sub>2</sub> interface from the inside through the lateral surface of a sample. A peak associated with tunneling of photons from Si to air through the NiSi<sub>2</sub> film is observed at grazing angles of  $\theta_1 > 0.4\theta_c$ , where  $\theta_c$  is the critical angle of total internal reflection at the Si/NiSi<sub>2</sub> interface. The integral intensity of tunneling peaks that is measured for various  $\theta_1$  angles agrees with the calculations. © 2005 Pleiades Publishing, Inc.

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The phenomenon of frustrated total internal reflection is well known in optics [1, 2]. The passage of radiation through a thin gap with an optically less dense medium under the formal conditions of total internal reflection is usually treated as tunneling of photons through an optical barrier. The effective wave-penetration depth  $z_e$  for grazing angles  $\theta_1$  smaller than the critical angle  $\theta_c$  of total internal reflection depends on the incident radiation wavelength  $\lambda$  and the environment parameters. For this reason, frustrated total internal reflection in optical and IR spectral ranges is widely used at present to analyze the composition and structure of thin films and interfaces [3–5]. For hard x-ray radiation with  $\lambda \sim 0.1$  nm, the refractive index decrement  $\delta = 1 - n$  ( $n$  is the refractive index) for most materials lies in the range  $10^{-6}$ – $10^{-5}$ . For these  $\delta$  values, total internal reflection can be observed only in a very narrow angular range. According to calculations and experimental data [6], the typical  $z_e$  values are 2–3 nm, which are less than one hundredth of the typical  $z_e$  values for the optical range.

Therefore, the direct observation of frustrated total internal reflection in the x-ray range is of fundamental and practical interest. In this work, we show that the effect can be detected under laboratory conditions and present the results of measurements of the angular distribution of the intensity of x-ray photon tunneling from silicon to air through the NiSi<sub>2</sub> thin film.

An optically polished Si single crystal disk was used as a substrate. The NiSi<sub>2</sub> film was deposited by the magnetron sputtering. The film was partially oxidized due to interaction with air. According to x-ray reflectometry, the thickness of the nonoxidized NiSi<sub>2</sub> film was equal to 12.8 nm. A plate 1-cm wide was made from the

central part of the disk by scribing from the side opposite to the film and subsequent splitting.

Measurements were carried out by means of an x-ray reflectometer whose x-ray optical scheme was described in [7]. A sharp focus x-ray tube with a copper anode was used as a radiation source. Figure 1 shows the position of a sample with respect to the incident radiation. A beam with an angular spread of 20'' was directed through the lateral surface of the sample. The edge of the lateral face of the sample was aligned with the reflectometer rotation axis. Thus, the flux density of the x-ray radiation incident on the lateral face remained constant under small rotations. The angular distribution of the intensity  $I(\psi)$  of radiation passed through the sample at fixed grazing angles  $\theta_1$  of the primary beam was measured by scanning by a receiving slit that had a width  $s$  of 30 or 100  $\mu\text{m}$  and was situated at a distance

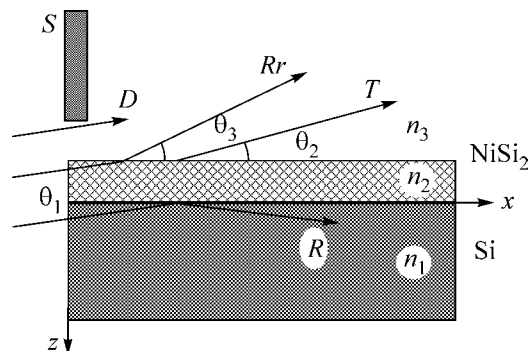
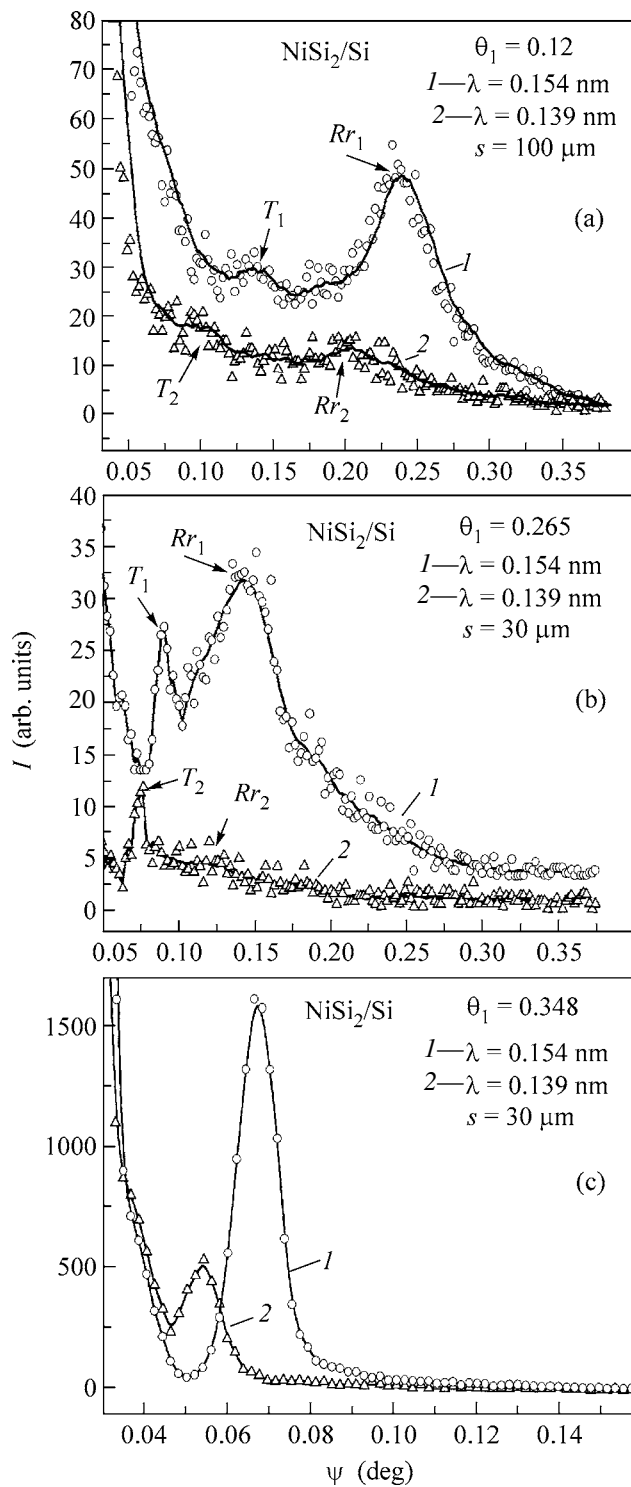


Fig. 1. Radiation passage scheme: (S) protection screen, (D) direct beam at grazing angle  $\theta_1$ , ( $Rr$ ) refracted beam at grazing angle  $\theta_3$ , ( $R$ ) reflected beam, and ( $T$ ) beam tunneling through NiSi<sub>2</sub> at grazing angle  $\theta_2$ .



**Fig. 2.** Angular distributions of the intensity of the radiation passed through the sample for the grazing angles of the primary beam  $\theta_1 =$  (a)  $0.12^\circ$ , (b)  $0.265^\circ$ , and (c)  $0.348^\circ$  and for (1)  $\text{CuK}_\alpha$  0.154-nm and (2)  $\text{CuK}_\beta$  0.139-nm lines; panels (a) and (b) correspond to the tunneling regions and panel (c), to the reflection region.

of 225 mm from the reflectometer axis. The deviation angle  $\psi$  of radiation passed through the sample was measured from the primary beam axis. The spectral

lines  $\text{CuK}_\alpha$  (0.154 nm) and  $\text{CuK}_\beta$  (0.139 nm) were separated by semitransparent monochromators from radiation passed through the receiving slit. The angular scanning step and the direct radiation flux at the  $\text{CuK}_\alpha$  line were equal to  $3.6''$  and  $10^6$  photons per second, respectively.

For the measurement geometry shown in Fig. 1, a certain part of the beam passed between the absorbing screen  $S$  and sample surface and was used as an angular reference. Another part of the beam passed through the lateral surface of the film and was refracted at the  $\text{NiSi}_2/\text{air}$  interface at the grazing angle  $\theta_3$ . The main part of the beam entering the substrate was absorbed in Si. Photons whose path in Si is smaller than the mean free path  $l_s$  of x-ray photons predominantly reach the Si/ $\text{NiSi}_2$  interface. The mean free path  $l_s$  for the  $\text{CuK}_\alpha$  and  $\text{CuK}_\beta$  lines is equal to 71 and 99  $\mu\text{m}$ , respectively. According to the table data [8],  $\delta(\text{Si}) = 7.57 \times 10^{-6}$  and  $\delta(\text{NiSi}_2) = 21.5 \times 10^{-6}$  for  $\lambda = 0.154$  nm; i.e., the necessary condition of the total internal reflection  $1 - \delta(\text{Si}) > 1 - \delta(\text{NiSi}_2)$  is satisfied at the Si/ $\text{NiSi}_2$  interface. Thus, this part of the x-ray flux can tunnel from Si to air through the  $\text{NiSi}_2$  film.

The condition of the passage of the wave front through the lateral surface of the substrate without significant distortion can be written in the form

$$\Delta L(n_3 - n_1)/\lambda = \Delta L\delta(\text{Si})/\lambda \ll 1, \quad (1)$$

where  $\Delta L$  is the mean height of ribs on the chip surface. Substituting the table  $\delta$  value for Si at  $\lambda = 0.154$  nm and, for definiteness, assuming that the left-hand side of the inequality is no more than 0.01, we obtain  $\Delta L < 0.2 \mu\text{m}$ . The above condition is easily satisfied on the chips of the single crystal along the cleavage planes within sections that are much larger than the diameter of the first Fresnel zone.

Figure 2 shows the measured angular distributions of the intensity  $I(\psi)$  of radiation passed through the sample at fixed grazing angles  $\theta_1$  of the primary beam. As was mentioned above, a sharp increase in the intensity for angles  $\psi \rightarrow 0$  is associated with the passage of a part of the direct beam over the sample edge. As follows from the geometry of the radiation, the broad peak on the right side of Figs. 2a and 2b arises due to the refraction of x-ray radiation passed through the end of the  $\text{NiSi}_2$  film. The corresponding refraction maxima are denoted as  $Rr_1$  and  $Rr_2$ . In the diagram measured on the  $\text{CuK}_\beta$  line, the  $Rr_2$  peak is lower than the background signal, which is caused by the jump in the photoabsorption in Ni for  $\lambda = 0.139$  nm. The tunneling flux can be measured beginning with the grazing angle  $\theta_1 = 0.12^\circ$  (Fig. 2a). The tunneling peaks for the two wavelengths in Figs. 2a and 2b are denoted as  $T_1$  and  $T_2$ . For grazing angles  $\theta_1 > \theta_c$  (Fig. 2c), only the intense peak of refracted radiation passing from silicon to air through the Si/film and film/air interfaces is observed.

Figure 3 shows (1) experimental and (2) theoretical dependences of the integral intensity  $\Phi$  of x-ray radiation passed through the film at the grazing angle  $\theta_1$  for  $\lambda = 0.154$  nm. The function  $\Phi$  values are obtained by numerically integrating the  $I(\psi)$  curve near the tunneling peak and subtracting the background signal. The angular range  $\theta_1 < \theta_c \approx 0.31^\circ$  is the tunneling region.

The angular dependence  $\Phi(\theta_1)$  is calculated under the following assumptions. We assume that the angular spread of the primary beam is negligible and the linear flux density  $p_0$  of x-ray photons incident on the end of the sample at the grazing angle  $\theta_1$  is constant. The  $z$  axis is perpendicular to the sample surface (see Fig. 1). In this case,

$$\Phi(\theta_1) = |t_1|^2 \int_0^\infty p_0 \exp\left(-\frac{\mu(z)z}{\sin\theta_1}\right) dz, \quad (2)$$

where  $p_0$  is the linear density of the x-ray flux incident on the sample and  $\mu$  is the linear coefficient of the absorption of radiation in the substrate for the given wavelength. The energy transmission coefficient  $T = |t_1|^2$  of the film structure is calculated from the recurrence relations [9]

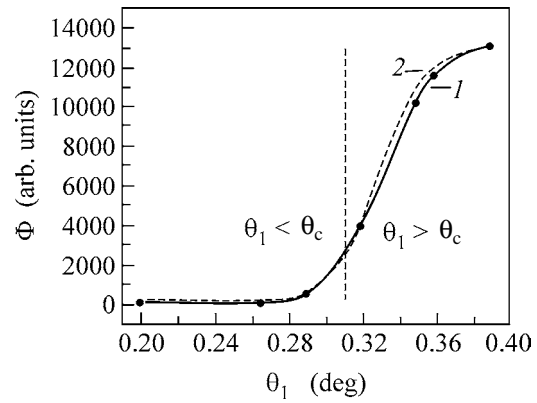
$$t_j = \frac{t_{j+1}^F t_j^F e^{i\kappa_2 d_j}}{1 + r_{j+1}^F r_j^F e^{2i\kappa_2 d_j}}, \quad (3)$$

$$r_j = \frac{r_j^F r_{j+1}^F e^{2i\kappa_{j+1} d_j}}{1 + r_{j+1}^F r_j^F e^{2i\kappa_{j+1} d_j}}. \quad (4)$$

Here,  $r_j$  and  $t_j$  are the complex amplitude coefficients of reflection and transmission of the structure, respectively;  $r_j^F$  and  $t_j^F$  are the Fresnel amplitude coefficients of reflection and transmission at the interfaces, respectively;  $\kappa = 2\pi/\lambda(\epsilon_j - \sin^2\varphi)^{1/2}$ , where  $\varphi = \pi/2 - \theta_1$  is the angle of incidence on the first interface and  $\epsilon_j$  is the dielectric constant of the medium in the  $j$ th layer; and  $d_j$  is the layer thickness.

Comparison shows that the experimental and theoretical curves are in fairly good agreement. The result shown in Fig. 3 is obtained with the effective film thickness  $D_f = 18.5$  nm, which testifies to the presence of an oxide layer. This conclusion is also corroborated by x-ray reflectometry. For grazing angles  $\theta_1 < 0.7\theta_c$ , the tunneling photon flux is lower than 1% of the reflected flux for  $\theta_1 \approx 1.1\theta_c$ . The conditional boundary between the regions of tunneling and refraction is shown in Fig. 3 by the vertical dashed straight line. The presence of the extended transient section on the curve  $\Phi(\theta_1)$  in the region  $\theta_1 \approx \theta_c$  is explained by the effect of the imaginary part of  $\epsilon$ .

In conclusion, we note that, for such materials as GaAs,  $\text{Al}_2\text{O}_3$ , Si, and fused silica that are most often used as substrates, the mean free path of photons for



**Fig. 3.** (1) Experimental and (2) theoretical angular dependences of the integral flux intensity of x-ray photons passed through the outer interface:  $\theta_1 < \theta_c$  is the tunneling region and  $\theta_1 > \theta_c$  is the refraction region.

$\lambda = 0.154$  nm and, correspondingly, the effective width of the tunneling region are in the range 30–140  $\mu\text{m}$ . These values are approximately two orders of magnitude smaller than the characteristic size of the irradiated region in x-ray reflectometry measurements. For this reason, the transmission measurement scheme proposed in this work can be used to analyze edge effects in the technology of producing film nanostructures and to control coatings on a nonflat surface with a curvature radius to 0.3–0.5 m.

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